, 安山縣

	7777	PATENT HUMBER
	U.S. UTLITY Patent App.  V. O. I.P.E.  SCANNED	PATENT DATE
APPLICATION NO. CONT/P 09/538469 F Kouki Ogawa Eiji Kodera	RIOR CLASS SUBCLASS ART U 257 281	
Capacitor-built substrate, and o	in type printed wiring sub capacitor 	bstrate, printed wiring PTC-2040 1299

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TERMINAL DISCLAIMER		4-				3/20/2		
			DRAWINGS			CLAIMS ALLOWED		
		Sheets Drwg.	Figs. Dry	vg.	Print Fig.	Total Claims		or O G
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been disclaimed.	(date)	Nathan (Assiste	W. H	4	/21/03 (Date)	i a	. MAIL	ED
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extend beyond the e	xpiration date	NIG			<u> </u>	<del></del>		_
<sub>k</sub>		LONG PHAM				ISSUE FEE		
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	===	/ (Primary	Examiner)	_7-	9-03 C	8/32		
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	claimed	(Legal instru	ents Examiner)		16.03			
NING:					(Sate)		i, Sections 122, 181 an	ł

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